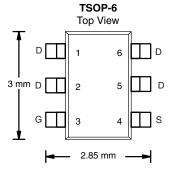


Vishay Siliconix

P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^{d,e}	Q _g (Typ.)			
	0.0192 at V_{GS} = -10 V	-8				
-30	0.0232 at V _{GS} = -6 V	-8	21 nC			
	0.0270 at V _{GS} = -4.5 V	-8				



FEATURES

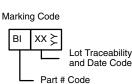
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Load Switches
- Adaptor Switch
- DC/DC Converter
- For Mobile Computing/Consumer





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Ordering Information:

Si3421DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	-30	v		
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		-8 ^e		
Continuous Drain Current ($T_1 = 150 \text{ °C}$)	T _C = 70 °C		-8 ^e		
Continuous Drain Current $(1_j = 150^{\circ} C)$	T _A = 25 °C	I _D	-8.3 ^{a, b}		
	T _A = 70 °C		-6.7 ^{a, b}		
Pulsed Drain Current (t = 100 µs)		I _{DM}	-50	A	
Continuous Course Durie Diada Current	T _C = 25 °C	1	-3.5		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	-1.7 ^{a, b}		
Avalanche Current L = 0.1 mH		I _{AS}	-15		
Single-Pulse Avalanche Energy	E _{AS}	11.25	mJ		
	T _C = 25 °C		4.2		
Maximum Dawar Dissinction	T _C = 70 °C	ь	2.7	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	2 ^{a, b}	VV	
	T _A = 70 °C	1 -	1.3 ^{a, b}		
Operating Junction and Storage Temperature Range	T _J , T _{stq}	-55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	40	62.5	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	25	30	0/11	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under steady state conditions is 110 °C/W.

d. Based on T_C = 25 °C.

e. Package limited.

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Si3421DV

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-		1		1	1	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$				V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			-18		1400	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA		4.6		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1		-3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			-5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-30			Α	
		V _{GS} = -10 V, I _D = -7 A		0.0160	0.0192	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = -6 V, I _D = -5 A		0.0193	0.0232		
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3 \text{ A}$			0.0270	1	
Forward Transconductance ^a		V _{DS} = -10 V, I _D = -7 A		30		S	
Dynamic ^b			1	1		1	
Input Capacitance	C _{iss}			2580			
Output Capacitance	C _{oss}	V _{DS} = -15 V, V _{GS} = 0 V, f = 1 MHz		256		pF	
Reverse Transfer Capacitance	C _{rss}			225			
•		V _{DS} = -15 V, V _{GS} = -10 V, I _D = -8.3 A		46	69		
Total Gate Charge	Qg			21	32		
Gate-Source Charge	Q _{gs}	V _{DS} = -15 V, V _{GS} = -4.5 V, I _D = -8.3 A		7		nC	
Gate-Drain Charge	Q _{gd}			6.1		1	
Gate Resistance	R _g	f = 1 MHz	1.6	8	16	Ω	
Turn-On Delay Time	t _{d(on)}			7	14		
Rise Time	t _r	V_{DD} = -15 V, R_{L} = 2.24 Ω		9	18	-	
Turn-Off DelayTime	t _{d(off)}	${\sf I}_{\sf D}\cong$ -6.7 A, ${\sf V}_{\sf GEN}$ = -10 V, ${\sf R}_{\sf q}$ = 1 Ω		55	83		
Fall Time	t _f			13	20		
Turn-On Delay Time	t _{d(on)}			58	87	ns	
Rise Time	t _r	V_{DD} = -15 V, R_{L} = 2.24 Ω		40	60	1	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ -6.7 A, V_{GEN} = -4.5 V, R_a = 1 Ω		36	54		
Fall Time	t _f			17	26		
Drain-Source Body Diode Characterist	ics		1	1		1	
Continous Source-Drain Diode Current		T _C = 25 °C			-3.5		
Pulse Diode Forward Current (t = $100 \mu s$)	I _{SM}				-50	Α	
Body Diode Voltage	V _{SD}	I _S = -6.7 A, V _{GS} = 0 V	1	-0.85	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			21.5	33	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = -6.7 A, dl/dt = 100 A/μs,		12	20	nC	
Reverse Recovery Fall Time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$		10.5	-		
Reverse Recovery Rise Time	t _b			11		ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

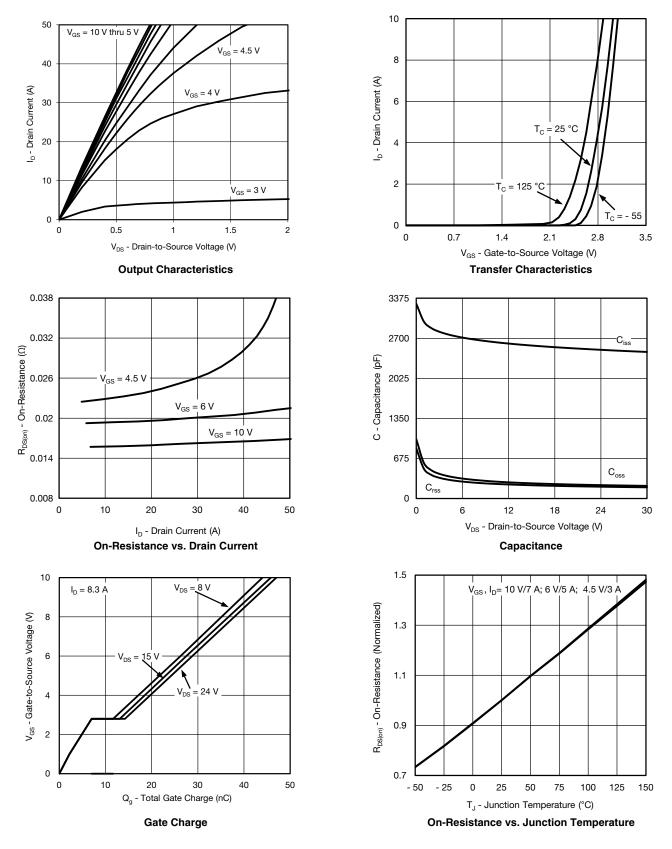
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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Si3421DV Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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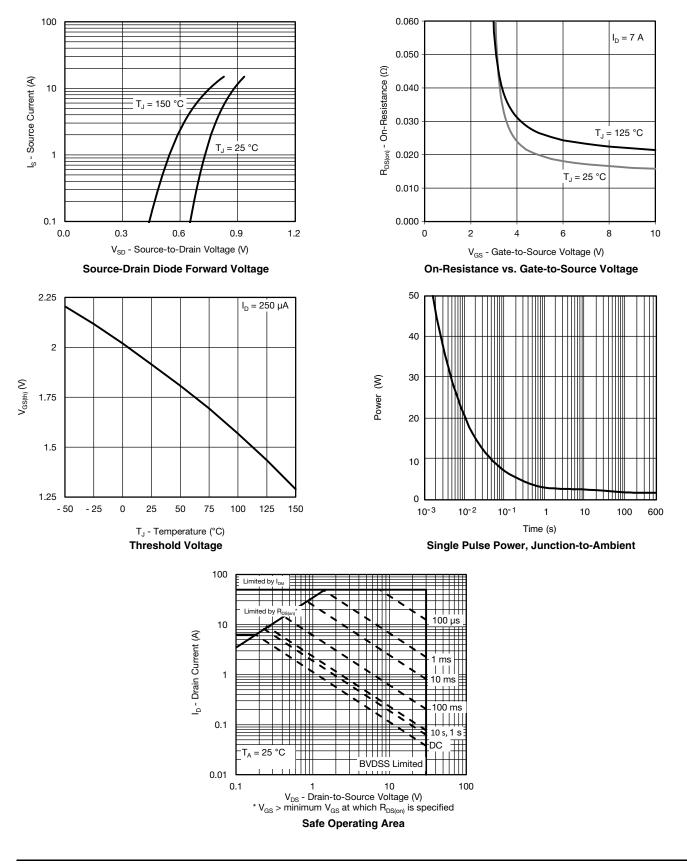
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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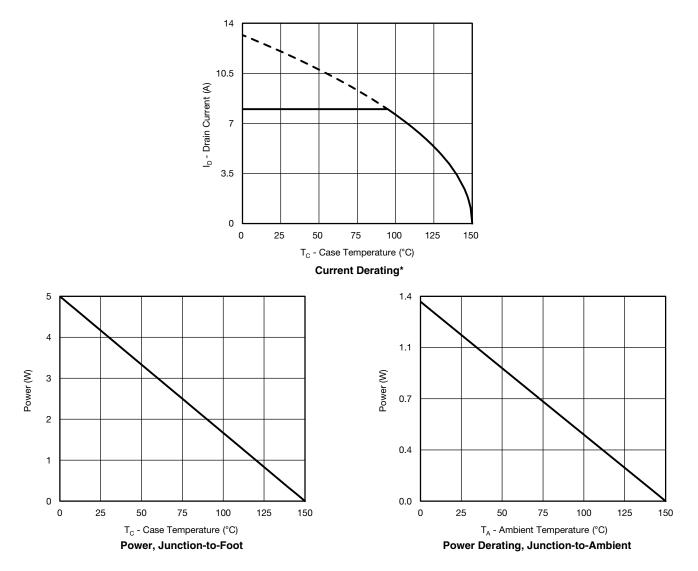
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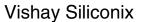
Si3421DV Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



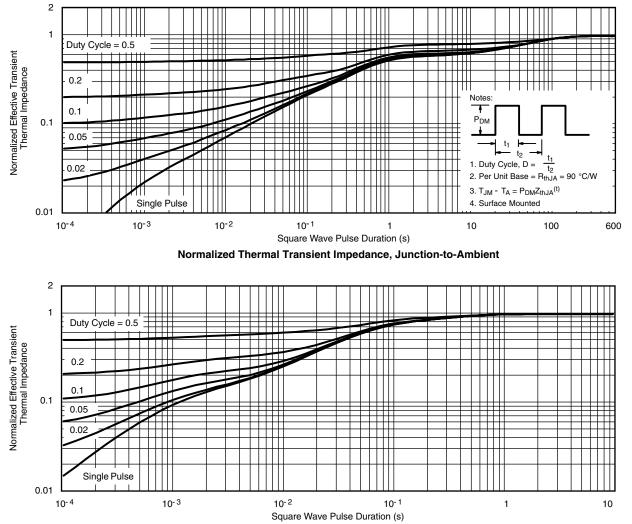
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si3421DV





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?62921</u>.

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Package Information

Vishay Siliconix

TSOP: 5/6-LEAD JEDEC Part Number: MO-193C









6-LEAD TSOP



	MIL	LIMETER	RS	INCHES						
Dim	Min	Nom	Max	Min	Nom	Max				
Α	0.91	-	1.10	0.036	-	0.043				
A ₁	0.01	-	0.10	0.0004	-	0.004				
A ₂	0.90	-	1.00	0.035	0.038	0.039				
b	0.30	0.32	0.45	0.012	0.013	0.018				
С	0.10	0.15	0.20	0.004	0.006	0.008				
D	2.95	3.05	3.10	0.116	0.120	0.122				
Е	2.70	2.85	2.98	0.106	0.112	0.117				
E ₁	1.55	1.65	1.70	0.061	0.065	0.067				
е	0.95 BSC			0.0374 BSC						
e ₁	1.80	1.90	2.00	0.071	0.075	0.079				
L	0.32	-	0.50	0.012	-	0.020				
L ₁	0.60 Ref				0.024 Ref					
L ₂	0.25 BSC				0.010 BSC					
R	0.10	-	-	0.004	-	-				
θ	0°	4°	8°	0°	4°	8°				
θ_1	7° Nom				7° Nom					
		ev. I, 18-Dec	c-06			ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540				

PAD Pattern



Vishay Siliconix

Recommended Land Pattern For TSOP-5L / TSOP-6L





TSOP 5L





Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022	
DWG: 3010	

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